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Towards miniaturization of concentrated photovoltaics (CPV): impact on fabrication, performance and robustness of solar cells

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Abstract— Micro-CPV is emerging with the potential to overcome conventional CPV weaknesses. With cells miniaturization, fabrication processes, electrical performance and potentially reliability are impacted. We present here improved fabrication techniques to provide high performance microcells and high wafer throughput. We demonstrate cells fabrication with active area ranging from 1 mm^2 to 0.076 mm^2 with 8.1 % reduced V_{oc} for smallest cells, attributed to perimeter surface recombination. All cells present no dramatic failure during passive or active ageing tests, which is promising for the future development of micro-CPV technologies.

Keywords—multijunction solar cells, micro-CPV, microfabrication, perimeter recombination, reliability

I. INTRODUCTION

Concentrated Photovoltaics (CPV) technology relies on the concentration of the sunlight onto small (typically mm^2 to cm^2) and highly efficient (III-V-based, typically triple junctions) cells. However, this-technology cost is still too high to be widely adopted. An emerging approach consists in miniaturizing modules dimensions (micro-CPV). Submillimeter multijunction cells are the cores of this innovative technology as they can overcome some of the limitations that make the standard CPV unwelcome. Low-temperature operation is the key for high electrical performance and for an improved reliability. Due to their small dimensions, easier strategies for thermal management can be offered with micro-cells [1]. In addition, smaller cells show less resistive losses thus higher efficiency is theoretically achievable under very high concentration.

Whereas micro-CPV and microcells seem of great interest, some challenges exist. First, fabrication processes must be adapted to provide good performance and high wafer

throughput, for which the conventional saw dicing is limiting. Second, perimeter recombination is known to affect electrical characteristics, and an efficient passivation appears to be necessary in order to lower performance losses. This is mitigated by saturation of traps under high-intensity illumination making microcells assuredly good candidates for high-concentration photovoltaics [2]. Perimeter effect was also shown to influence the reliability of GaAs 1-mm^2 solar cells, but no investigation focused on impact of size on multijunction solar cells reliability to our knowledge was reported [3]. CPV-cells operating conditions are complex (high-intensity light, heat, temperature variations, humidity, etc.) and thus, accelerated ageing tests design is not straightforward. A conventional technique used by the CPV community for simulating cell photogeneration ageing deals with active storage, in which cells are current-biased during the accelerated tests [3]–[7]. However, such a bias is quite different from operating conditions [6]. Passive thermal storage has also been considered but was demonstrated to be more aggressive to CPV cells compared to active storage [7]. Therefore, no perfect solution exists and ageing tests need to be considered with hindsight.

In this paper, we propose processes based on microfabrication techniques to fabricate InGaP/(In)GaAs/Ge CPV cells with submillimeter dimensions (down to 0.068 mm^2). One-sun characterization of cells from 1 mm^2 to 0.076 mm^2 shows the dependency between electrical performance and cell size, which highlights perimeter recombination. The effect of reducing cell dimensions on long-term performance is also investigated. Two strategies of accelerated ageing tests, based on thermal step stress, are developed: a passive (thermal stress only) and an active (thermal + current stress) test. Whereas the type of test shows different behaviors of performance changes,

the 0.076-mm² cells have demonstrated a good robustness, higher than the one of 1-mm² cells. Finally, the impact of perimeter recombination effect on cells degradation is discussed, as well as the impact of test type on performance.

II. DEVICES FABRICATION

A commercial structure of InGaP/(In)GaAs/Ge was chosen as the building block to develop the fabrication processes. The first step consists in depositing Al-based or Au-based contacts as emitter electrodes to define the front contact grid. Cells are then electrically isolated in individual devices, using inductively coupled plasma etching (ICP) with a combination of SiCl₄, Cl₂ and H₂ [8]. Then, the Al-based or Au-based base contact is deposited by evaporation either on the backside of the wafer or on the front side close to the mesa. Both contact methods lead to the same electrical results [2]. Then, an antireflective coating (ARC) made of SiN_xH_y/SiO_xH_y is deposited by plasma-enhanced chemical vapor deposition (PECVD). Besides increasing optical absorption of the cell, such ARC permits a passivation effect, which can limit perimeter recombination rate [9]. The ARC is then opened on metallization to access the electrical contacts. The fabrication processes ends by singulating cells from the wafer. This step is performed by plasma dicing [10]. Indeed, compared to the conventional saw dicing, plasma dicing offers a stress-and-damages-free singulation with flexibility in the desired cell shapes. Moreover, narrow dicing lines offered by such technique (10-μm) allow the wafer yield to be more than doubled with microcells, compared to saw dicing. After this step, devices fabrication is complete and Fig. 2 shows some examples of fabricated front-contacted cells, with various shapes (rectangular, hexagonal or circular active area), dimensions (from 12.25 mm² to 0.068 mm²) and contact methods (front or standard contacts).

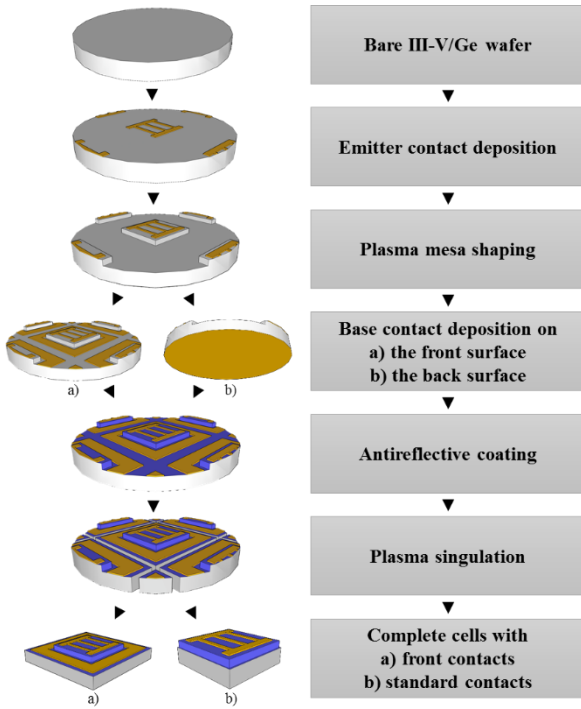


Fig. 1. Major steps for fabrication of solar cells with a) front contacts and b) standard contacts.

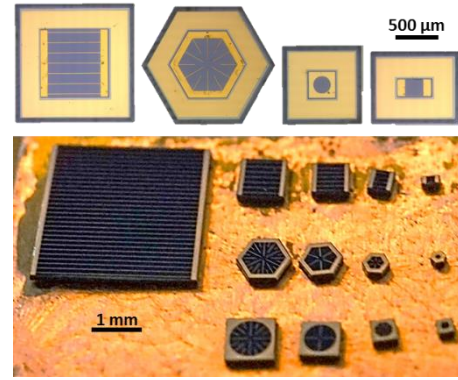


Fig. 2. Images of fabricated solar cells with front contacts (top) and standard contacts (bottom). Cell area ranges from 12.25 mm² to 0.068 mm²

III. ELECTRICAL PERFORMANCE

Fabricated cells were characterized under one-sun illumination (1000 W/m², AM1.5g, 25 °C) with an Oriel 1A solar simulator. In Fig. 3, current densities (J) of rectangular cells with mesa surface of 1 mm², 0.25 mm² and 0.076 mm² are plotted along voltage (V). All cells show good characteristics with open-circuit voltage (V_{OC}) > 2.12 V and fill factor (FF) > 82 %. The changes in cell size do not affect the J_{SC} . Extracted FF are between 82.3 % (0.076-mm² cell) and 85.4 % (1-mm² cell). The slight decrease of FF as the cell size decreases is related to the V_{OC} drop [12]. Indeed, a V_{OC} decrease of 4.4 % can be seen from the plot when cell area is reduced from 1 mm² to 0.25 mm². This V_{OC} decline reaches 8.1 % when cell area is reduced from 1 mm² to 0.076 mm². All cells were fabricated with the same processes and with the same epitaxial structures, which implies bulk recombination rates are assumed to be the same for all cells. Therefore, the reduction in V_{OC} can be attributed to perimeter recombination effect.

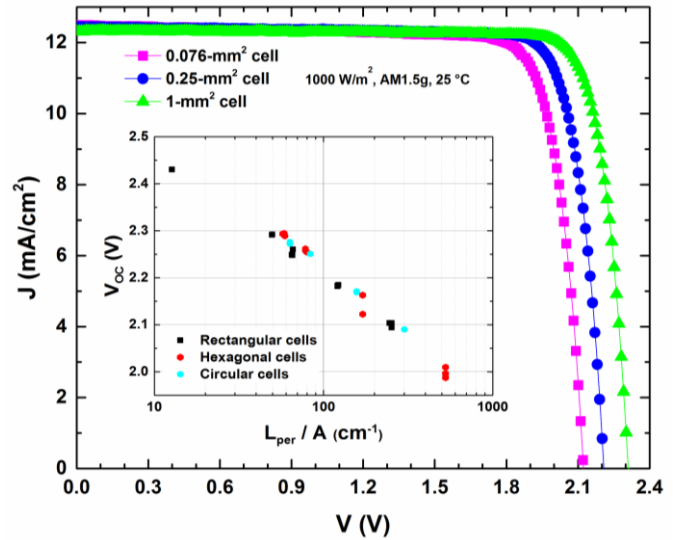


Fig. 3. Current density vs voltage characteristics of 0.076-mm², 0.25-mm² and 1-mm² cells. The inset figure shows the open-circuit voltage of cells with various dimensions and geometries along perimeter-to-area ratio.

Based on a simple one-diode model, one can express V_{OC} of a 3-junction cell as:

$$V_{OC} \approx \sum_{i=1}^3 n_i \frac{kT}{q} \ln \left[\frac{J_{L,i}}{J_{0,i}} \right] \quad (1)$$

where n_i is the diode ideality factor of subcell i , which depends on the recombination processes that occur in the subcell, k is the Boltzmann constant, T is the temperature, q is the electron charge, $J_{L,i}$ is the photogenerated current density of subcell i and $J_{0,i}$ is the reverse saturation dark current density of subcell i . $J_{0,i}$ can be expressed as:

$$J_{0,i} = J_{01,i} + J_{02,scr,i} + J_{02,per,i} \quad (2)$$

where $J_{01,i}$ is the saturation current density associated with diffusion process in subcell i , $J_{02,scr,i}$ is the saturation current density associated with the effects in space charge region in subcell i and $J_{02,per,i}$ is the saturation current density resulting from recombination at the perimeter of subcell i . The latter parameter can be written as:

$$J_{02,per,i} = qn_i S_{0,i} L_{S,i} \frac{L_{per}}{A} \quad (3)$$

where $S_{0,i}$ is the surface recombination velocity in subcell i , $L_{S,i}$ is the diffusion length of subcell i , L_{per} is the cell perimeter and A is the cell area.

Therefore, the quasi-linear relation between V_{OC} and perimeter-to-area ratio $\frac{L_{per}}{A}$ observed on the inset of Fig. 3 indicates that J_0 of at least one subcell varies linearly with $\frac{L_{per}}{A}$ and perimeter recombination is more significant than other contributions to the dark current. This proves the high influence of perimeter recombination on small-dimensions cells performance. Dedicated surface passivation could further limit perimeter recombination rate by efficiently passivating recombination centers. Moreover, perimeter recombination centers become saturated under high-intensity light. In a previous study, we demonstrated that the drop in V_{OC} due to small dimensions turns to be insignificant under high concentration (< 2.0 % under ~1300 X, even in the absence of a passivating ARC) [2]. Therefore, microcells are particularly of interest for highly concentrated photovoltaics not only thanks to their reduced resistive losses but also to their better efficiency under higher concentration.

IV. ROBUSTNESS ASSESSMENT

A. Accelerated Test Overview

Accelerated life tests can be divided in two categories: quantitative and qualitative tests. On the one hand, quantitative accelerated life tests aim at extracting a device lifetime, with the mean time to failure ($MTTF$) for example. This last can be predicted by observing the cumulated failure distribution during accelerated life test and by extrapolating it to the operation

conditions, using an adequate model depending on accelerated parameters (I , V , T , ...). It is generally performed on a large number of mature devices from a technological point of view. On the other hand, qualitative tests, that are typically highly accelerated life tests (HALT), aim at highlighting failure modes. It is often coupled with failure analysis to determine the physical mechanisms responsible for the failure. Qualitative ageing tests are typically preliminary tests performed with low-maturity technology to give a feedback particularly on the variability of fabrication processes. Step stress ageing tests (SSAT) are HALT that gradually increase a given stress or a combination of stress parameters on the devices. Multiple parameters can be stressing, but the most relevant parameter is temperature, as most degradation mechanisms are affected by thermal effects.

CPV cells, due to the high-intensity light they convert, are often considered to operate at up to 80 °C, with a nominal operating temperature of 65 °C for 1-mm² cells operating under 1000 X [4], [5]. Besides high temperature, CPV cells are submitted to large photocurrent densities resulting from the high light intensity they convert into electricity under concentration. Therefore, the most common method for simulating photogeneration during accelerated life tests consists in injecting in the cell a current similar to the one generated in operating conditions.

B. Experimental Procedure

In our study, SSAT were designed with a gradual temperature storage (passive stress, PSSAT) in a first case and with a gradual temperature storage together with a constant current injection equivalent to 1000 × I_{SC} (active stress, ASSAT) in a second case. Storage temperature was increased by 20 °C after each week (168 h), from 85 °C to 185 °C (PSSAT) and from 65 °C to 185 °C (ASSAT). Step stress temperature storage profiles are shown in Fig. 4 and parameters are summarized in Table 1. Electrical characterization was performed after each ageing step (see Fig 4) with a Keithley 2420 by removing the cells from the thermal chamber and characterizing them under a one-sun illumination

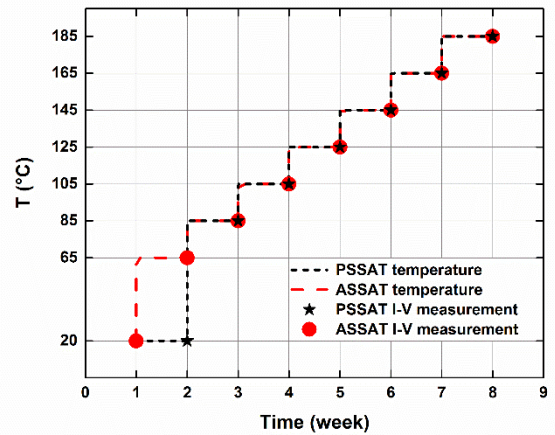


Fig. 4. Stress profiles and I - V measurement occurrences in PSSAT and ASSAT

TABLE I. STEP STRESS ACCELERATED TEST CONDITIONS AND DEVICES UNDER TEST

Step stress accelerated test	Test conditions		Devices under test	
	Thermal stress	Current injection	Type	Number
Passive (PSSAT)	From 85 °C to 185 °C	none	Bare cells	6 cells, 3 sizes
	168 h steps 20 °C increase between each step			
Active (ASSAT)	From 65 °C to 185 °C	Equivalent to $1000 \times I_{SC}$	Assembled cells	9 cells, 3 sizes

(AM1.5g, 1000 W/m², 25 °C). An Oriel 1A simulator was used for the PSSAT and an Oriel LCS100 simulator was used for the ASSAT. Electrical parameters of cells under test, extracted from under-illumination *I-V* measurements, were monitored as degradation modes. In this work, we focus on the changes in performance by observing the power at the maximum power point (P_{MPP}) and the open-circuit voltage (V_{OC}).

In the PSSAT, six rectangular bare cells of 1 mm², 0.25 mm² and 0.076 mm² (two per size) were considered. In this case, cells are not singulated and the base contact is located onto the back surface of the Germanium substrate. Cells are bonded on a copper-covered FR4 board with Indium as shown on Fig.5.a). *I-V* measurements under one sun are done by contacting cells with probes. In the ASSAT case, rectangular cells (with base contact on the back surface) were fabricated with the same processes as presented previously. However, nine cells (1 mm², 0.25 mm² and 0.076 mm², three per area) were saw-diced and mounted on Al carriers. Al-wirebonding was used for the front contact and SAC 305 as die-attach. A thermistor was also assembled on each carrier to control temperature of the package. A photograph of a 0.076-mm² cell package is given in Fig.5.b).

C. Electrical Performance Monitoring

In Fig. 6 performance changes in solar cells of after the PSSAT (step stress thermal storage) are depicted. We observe that all cells were degraded by the ageing test as a global decline in P_{MPP}/P_{MPP0} occurs. The P_{MPP}/P_{MPP0} is finally extracted between 0.825 (0.076-mm² cell A) and 0.957 (1-mm² cell B) and no catastrophic failure were observed. This validates the relative robustness of the developed fabrication processes for all cell dimensions. In addition, a clear dependence between cell size and P_{MPP} changes can be observed. Indeed, a trend

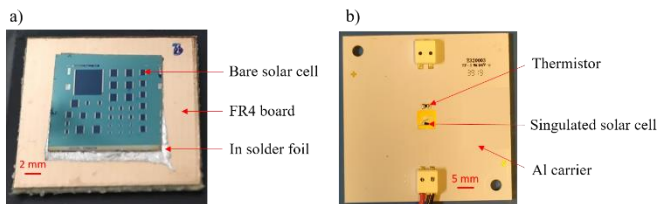


Fig. 5. Photographs of a) a sample with 35 bare cells assembled on a FR4 board for the PSSAT and b) a 0.076-mm² singulated cell on a Al carrier for the ASSAT.

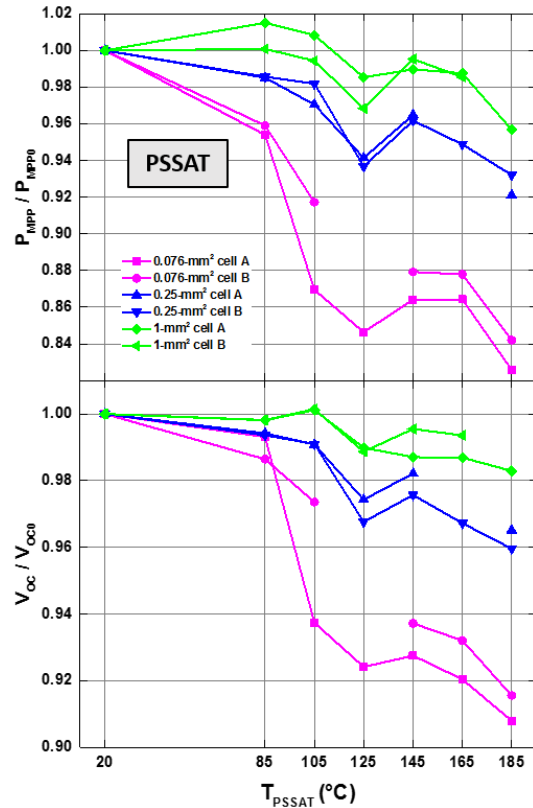


Fig. 6. Performance changes of cells with various size along temperature of the passive step stress ageing test (PSSAT). Top: Variations of the maximal power P_{MPP} , relative to the initial value P_{MPP0} and bottom: variations of the open-circuit voltage V_{OC} , relative to the initial value V_{OC0} .

appears for which the smaller cells are more affected by the P_{MPP}/P_{MPP0} decrease. The difference in P_{MPP}/P_{MPP0} due to cell size can be identified as soon as the first ageing step at 85 °C. The gap due to cell size is extending until the 125-°C step. This indicates that degradation processes that affect cells by their size occur at relatively low temperature. After 125 °C, changes in P_{MPP}/P_{MPP0} are very similar, within 5.5 %, regardless the cell size. These processes also affect the V_{OC} as can be seen in the bottom part of the same figure. Based on (1) and (2), V_{OC} monitoring can give information on the recombination processes. We can observe on the V_{OC}/V_{OC0} plot that changes follow the same trend as the one observed for P_{MPP}/P_{MPP0} . Indeed, at the end of the PSSAT, V_{OC}/V_{OC0} clearly depends on cell dimensions with a low value of 0.908 for the 0.076-mm² cell and a high value of 0.983 for the 1-mm² cell. These results indicate an increasing impact of recombination with the miniaturization of the cells after PSSAT. However, results are very encouraging for this non-mature technology as no catastrophic failure was observed, even with the high stress level induced by the ageing test.

Fig. 7 illustrates the effects of ASSAT (step stress thermal storage + current injection $\equiv 1000 \times I_{SC}$) on the electrical performances of cells, depending on their size. In the top part of Fig. 7, we observe a global decrease of the P_{MPP}/P_{MPP0} , proving that all cells were degraded by the ASSAT. The final values for P_{MPP}/P_{MPP0} are comprised between 0.931

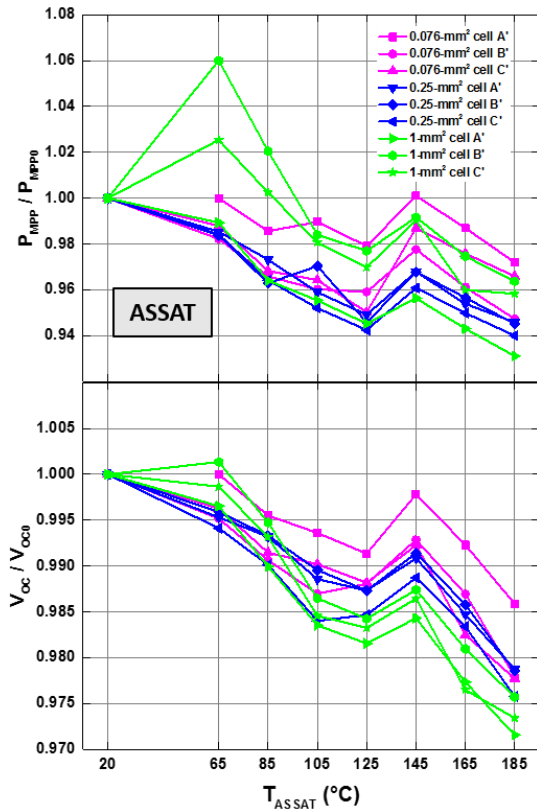


Fig. 7. Performance changes of cells with various size along temperature of the passive step stress ageing test (ASSAT). Top: Variations of the maximal power, relative to the initial value and bottom: variations of the open-circuit voltage, relative to the initial value.

(1-mm² cell) and 0.972 (0.076-mm² cell), which is higher than the ones observed in the PSSAT, confirming the robustness of the fabricated cells. We can notice that besides fluctuations, no clear trend of variations with cell size can be observed on the P_{MPP}/P_{MPP0} plot. However, whereas the V_{OC} of all cells is affected, it can be seen that the one of 1-mm² cells is slightly more affected (i.e. decrease of 1.4 %) by ageing and V_{OC}/V_{OC0} ratio is equal to 0.972 for 1-mm² cell A' and 0.986 for 1-mm² cell A' by the end of the ASSAT. Considering that quite high stressing conditions have been considered ($T_{ASSAT} = 185$ °C and a constant current injection of $1000 \times I_{SC}$), very small variations of the electrical parameters have been observed. Whereas the effect of cell size on P_{MPP} is not so clear than for PSSAT, microcells and larger cells have shown very good robustness under ASSAT.

The difference between PSSAT and ASSAT can be explained by more aggressive stress conditions for thermal storage only, as previously reported by Eltermann *et al.*, or by the thermal step at 230 °C required for cells mounting process used for ASSAT that may have slightly modified the cells [7].

V. CONCLUSION & DISCUSSION

In this work, cells were fabricated with microfabrication processes to allow various geometries and dimensions down to 0.068 mm², with standard or front base contacts. The use of microelectronics-inspired processes allowed high wafer throughput. Performance of the smaller cells are affected by

perimeter recombination, which dominate the recombination mechanisms that take place in the cells. A V_{OC} drop of 8.1 % under one sun was measured when reducing cell area from 1 mm² to 0.076 mm² but becomes negligible under high concentration illumination.

A study of the robustness of the fabricated cells was also performed. Both passive and active step stress accelerated tests (PSSAT and ASSAT) were considered and designed to investigate the impact of the cell size on their long-term performance. Whereas no catastrophic failure was observed, higher performance changes occurred in the PSSAT with a minimum P_{MPP}/P_{MPP0} of 0.825 at the end of the test (up to 185 °C). Similarly, Eltermann *et al.* have shown that thermal storage only, compared to thermal storage coupled with current injection and current injection only, led to the most severe degradation of the CPV cells [7]. However, using current injection in ageing tests is often considered as a correct stressing method by the CPV community to simulate photogeneration. These combined stresses aim at better highlighting degradation mechanisms susceptible to appear in real-conditions operation, with a current flowing through the junctions and contacts. Using this technique, we have shown a very promising minimum P_{MPP}/P_{MPP0} of 0.931 at the end of the ASSAT. These results are very encouraging although active ageing may create degradations different from the ones related to nominal-conditions operation. Indeed, it was shown that current injection generates a very different current density distribution in the cell structure [6]. This may overstress some part while being too gentle on other and lead to degradation dissimilarities. However, no failure analysis was intended in this robustness investigation work. It was finally demonstrated a globally higher robustness of the smallest cells (0.076 mm²) with a maximum P_{MPP}/P_{MPP0} of 0.972 at the end of the ASSAT (185 °C). From the results obtained in our study, a similar a lifespan in operating conditions for microcells compared to larger cells is expected. Further works will include a comprehensive analysis of the measured degradations.

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